AMPMODU | AMPMODU Headers

TE Internal #: 2-827064-0

PCB Mount Header, Vertical, Board-to-Board, 20 Position, 2.54 mm

[.1 in] Centerline, Breakaway, Tin (Sn), Through Hole - Solder,

AMPMODU Headers

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PCB Connector Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 20
Number of Rows: 1

Features

Product Type Features

PCB Connector Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Breakaway
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly

Configuration Features

Connector Contact Load Condition	Fully Loaded
Board-to-Board Configuration	Parallel
PCB Mount Orientation	Vertical
Number of Positions	20
Number of Rows	1

Electrical Characteristics

Insulation Resistance	5000 ΜΩ
Dielectric Withstanding Voltage (Max)	750 Vrms

Body Features

Contact Features



Contact Underplating Material	Nickel
Contact Mating Area Plating Material Thickness	2.5 μm[98.43 μin]
Mating Square Post Dimension	.63 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	2.5 µm
Contact Shape & Form	Square
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material	Tin (Sn)
Contact Type	Pin
Contact Current Rating (Max)	5 A
Termination Features	
Termination Post & Tail Length	3.18 mm[.125 in]
Square Termination Post & Tail Dimension	.63 mm[.025 in]
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Mating Alignment	Without
Housing Features	
Housing Material	PBT
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
PCB Thickness (Recommended)	1.57 mm[.062 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0



Packaging Features

Packaging Quantity	200
Packaging Method	Box

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | AMPMODU Headers





Automotive Headers(1)



Board-to-Board Headers & Receptacles(1576)



Connector Contacts(47)



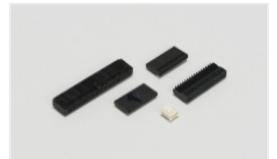
Connector Hardware(1)



PCB Headers & Receptacles(1621)



Rectangular Power Connectors(43)



Wire-to-Board Connector Assemblies & Housings(5)



Wire-to-Board Headers & Receptacles (114)

Customers Also Bought











TE Part #CAT-T3437-ST2999 STD Snap-On Markers



Documents

Product Drawings 20P MOD2 STIFT LEI

English

Agency Approvals

UL

English